

Molding Type Module IGBT, Chopper in 1 Package, 1200 V and 300 A



Double INT-A-PAK

FEATURES

- Low $V_{CE(on)}$ SPT + IGBT technology
- 10 μ s short circuit capability
- $V_{CE(on)}$ with positive temperature coefficient
- Low inductance case
- Fast and soft reverse recovery antiparallel FWD
- Isolated copper baseplate using DCB (Direct Copper Bonding) technology
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

PRODUCT SUMMARY	
V_{CES}	1200 V
I_C at $T_C = 80\text{ }^\circ\text{C}$	300 A
$V_{CE(on)}$ (typical) at $I_C = 300\text{ A}$, $25\text{ }^\circ\text{C}$	2.0 V
Speed	8 kHz to 30 kHz
Package	Double INT-A-PAK
Circuit	Chopper low side switch

TYPICAL APPLICATIONS

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply (UPS)

DESCRIPTION

Vishay's IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. It is designed for applications such as general inverters and UPS.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	V_{CES}		1200	V
Gate to emitter voltage	V_{GES}		± 20	
Collector current	I_C	$T_C = 25\text{ }^\circ\text{C}$	500	A
		$T_C = 80\text{ }^\circ\text{C}$	300	
Pulsed collector current	$I_{CM}^{(1)}$	$t_p = 1\text{ ms}$	600	
Diode continuous forward current	I_F	$T_C = 80\text{ }^\circ\text{C}$	300	
Diode maximum forward current	I_{FM}	$t_p = 1\text{ ms}$	600	
Maximum power dissipation	P_D	$T_J = 150\text{ }^\circ\text{C}$	1645	
Short circuit withstand time	t_{SC}	$T_J = 125\text{ }^\circ\text{C}$	10	μ s
RMS isolation voltage	V_{ISOL}	$f = 50\text{ Hz}$, $t = 1\text{ min}$	2500	V

Note

⁽¹⁾ Repetitive rating: pulse width limited by maximum junction temperature.



IGBT ELECTRICAL SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	$V_{(BR)CES}$	$T_J = 25\text{ }^\circ\text{C}$	1200	-	-	V
Collector to emitter voltage	$V_{CE(on)}$	$V_{GE} = 15\text{ V}, I_C = 300\text{ A}, T_J = 25\text{ }^\circ\text{C}$	-	2.0	-	
		$V_{GE} = 15\text{ V}, I_C = 300\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	2.2	-	
Gate to emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C = 12.0\text{ mA}, T_J = 25\text{ }^\circ\text{C}$	5.0	6.2	7.0	
Collector cut-off current	I_{CES}	$V_{CE} = V_{CES}, V_{GE} = 0\text{ V}, T_J = 25\text{ }^\circ\text{C}$	-	-	5.0	mA
Gate to emitter leakage current	I_{GES}	$V_{GE} = V_{GES}, V_{CE} = 0\text{ V}, T_J = 25\text{ }^\circ\text{C}$	-	-	400	nA

SWITCHING CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600\text{ V}, I_C = 300\text{ A}, R_g = 4.7\text{ }\Omega, V_{GE} = \pm 15\text{ V}, T_J = 25\text{ }^\circ\text{C}$	-	574	-	ns
Rise time	t_r		-	133	-	
Turn-off delay time	$t_{d(off)}$		-	563	-	
Fall time	t_f		-	120	-	
Turn-on switching loss	E_{on}	$V_{CC} = 600\text{ V}, I_C = 300\text{ A}, R_g = 4.7\text{ }\Omega, V_{GE} = \pm 15\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	23.9	-	mJ
Turn-off switching loss	E_{off}		-	25.3	-	
Turn-on delay time	$t_{d(on)}$		-	604	-	
Rise time	t_r		-	137	-	
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 600\text{ V}, I_C = 300\text{ A}, R_g = 4.7\text{ }\Omega, V_{GE} = \pm 15\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	629	-	ns
Fall time	t_f		-	167	-	
Turn-on switching loss	E_{on}		-	31.5	-	
Turn-off switching loss	E_{off}		-	35.9	-	
Input capacitance	C_{ies}	$V_{GE} = 0\text{ V}, V_{CE} = 25\text{ V}, f = 1.0\text{ MHz}$	-	21.2	-	nF
Output capacitance	C_{oes}		-	1.42	-	
Reverse transfer capacitance	C_{res}		-	0.94	-	
SC data	I_{SC}	$t_{sc} \leq 10\text{ }\mu\text{s}, V_{GE} = 15\text{ V}, T_J = 125\text{ }^\circ\text{C}, V_{CC} = 900\text{ V}, V_{CEM} \leq 1200\text{ V}$	-	1800	-	A
Internal gate resistance	R_g		-	1.0	-	Ω
Stray inductance	L_{CE}		-	-	20	nH
Module lead resistance, terminal to chip	$R_{CC'+EE'}$	$T_C = 25\text{ }^\circ\text{C}$	-	0.35	-	m Ω

DIODE ELECTRICAL SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$ unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Diode forward voltage	V_F	$I_F = 300\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	-	1.82	2.25	V
			$T_J = 125\text{ }^\circ\text{C}$	-	1.95	-	
Diode reverse recovery charge	Q_{rr}	$I_F = 300\text{ A}, V_R = 600\text{ V}, di_F/dt = -2360\text{ A}/\mu\text{s}, V_{GE} = -15\text{ V}$	$T_J = 25\text{ }^\circ\text{C}$	-	20.2	-	μC
			$T_J = 125\text{ }^\circ\text{C}$	-	40.1	-	
Diode peak reverse recovery current	I_{rr}		$T_J = 25\text{ }^\circ\text{C}$	-	170	-	A
			$T_J = 125\text{ }^\circ\text{C}$	-	250	-	
Diode reverse recovery energy	E_{rec}	$T_J = 25\text{ }^\circ\text{C}$	-	8.2	-	mJ	
		$T_J = 125\text{ }^\circ\text{C}$	-	21.7	-		



THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction temperature	T_J		-	-	150	°C
Storage temperature range	T_{STG}		-40	-	125	
Junction to case	IGBT				0.076	K/W
	Diode					
Case to sink	R_{thCS}	Conductive grease applied	-	0.035	-	
Mounting torque		Power terminal screw: M6	2.5 to 5.0			
		Mounting screw: M6	3.0 to 5.0			
Weight			300			g

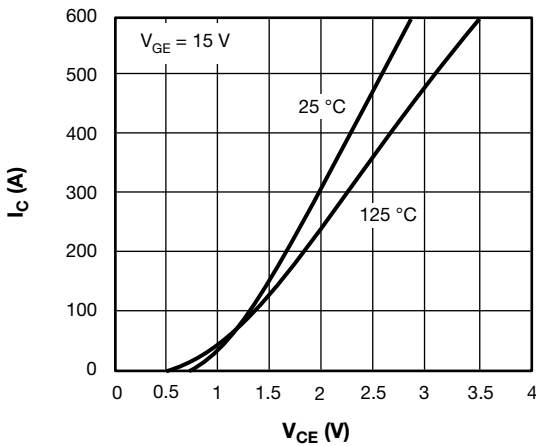


Fig. 1 - IGBT Typical Output Characteristics

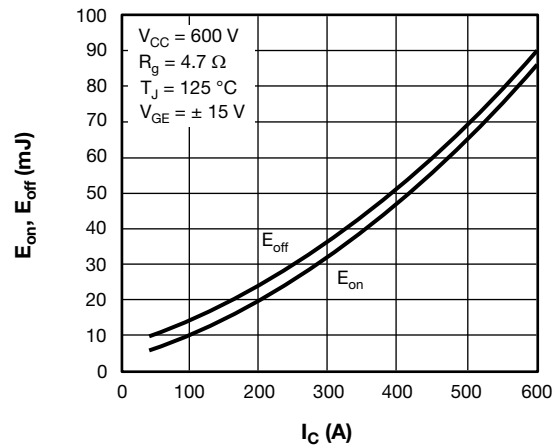


Fig. 3 - IGBT Switching Loss vs. I_C

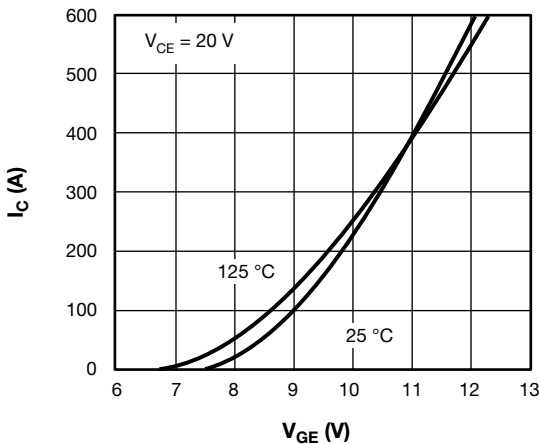


Fig. 2 - IGBT Typical Transfer Characteristics

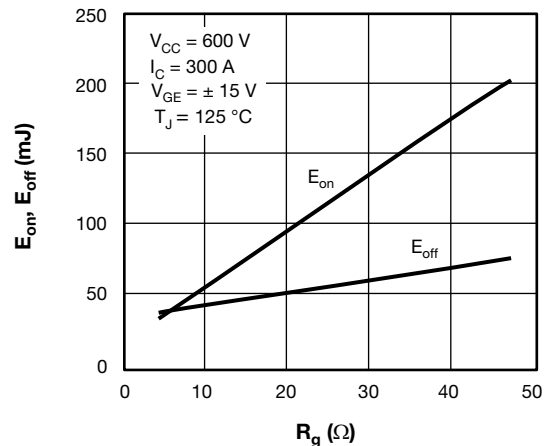


Fig. 4 - IGBT Switching Loss vs. R_g

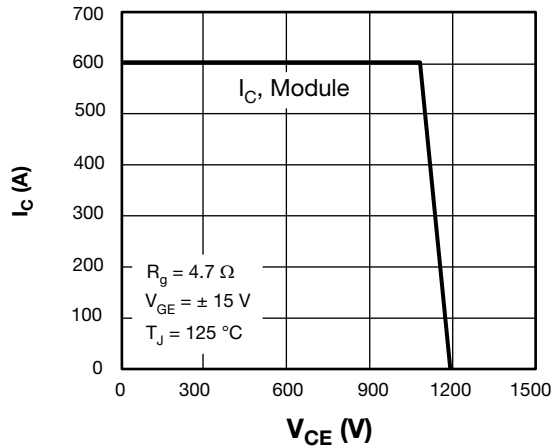


Fig. 5 - RBSOA

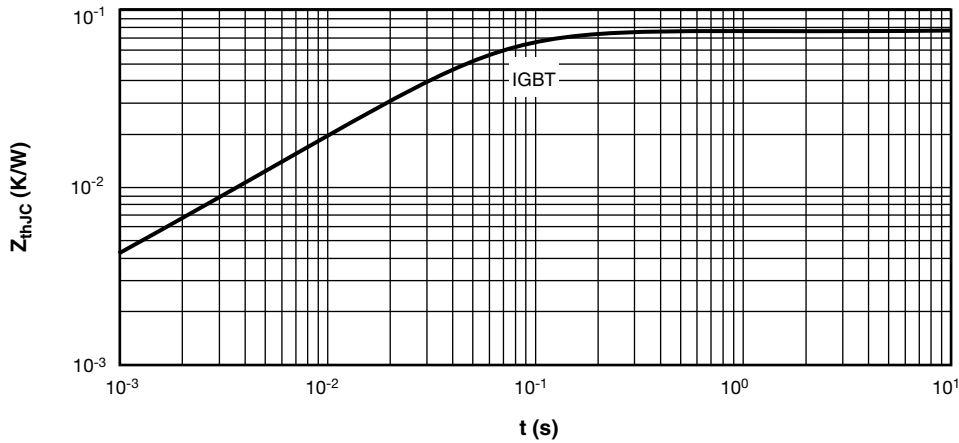


Fig. 6 - IGBT Transient Thermal Impedance

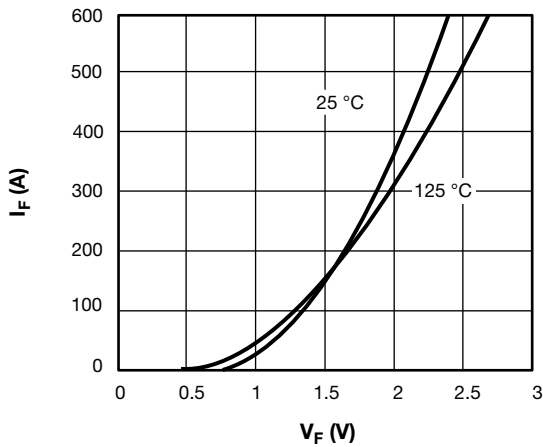


Fig. 7 - Diode Typical Forward Characteristics

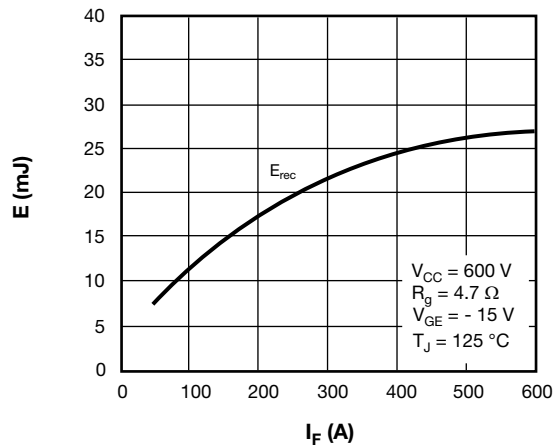


Fig. 8 - Diode Switching Loss vs. I_F

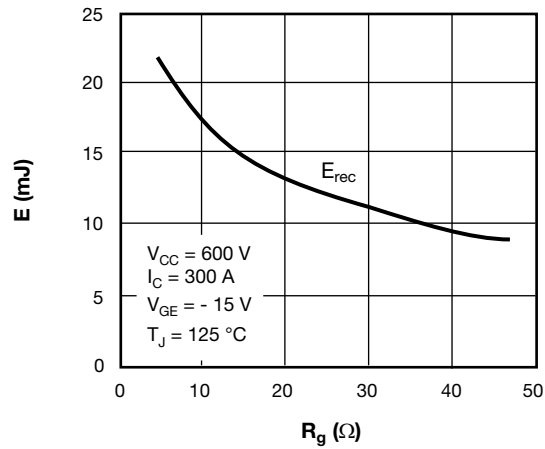


Fig. 9 - Diode Switching Loss vs. R_g

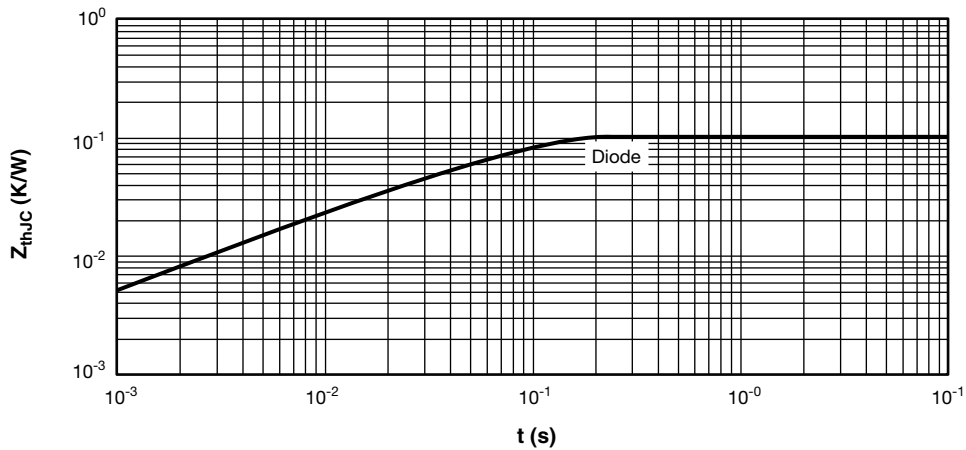
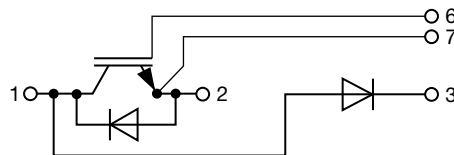


Fig. 10 - Diode Transient Thermal Impedance

CIRCUIT CONFIGURATION



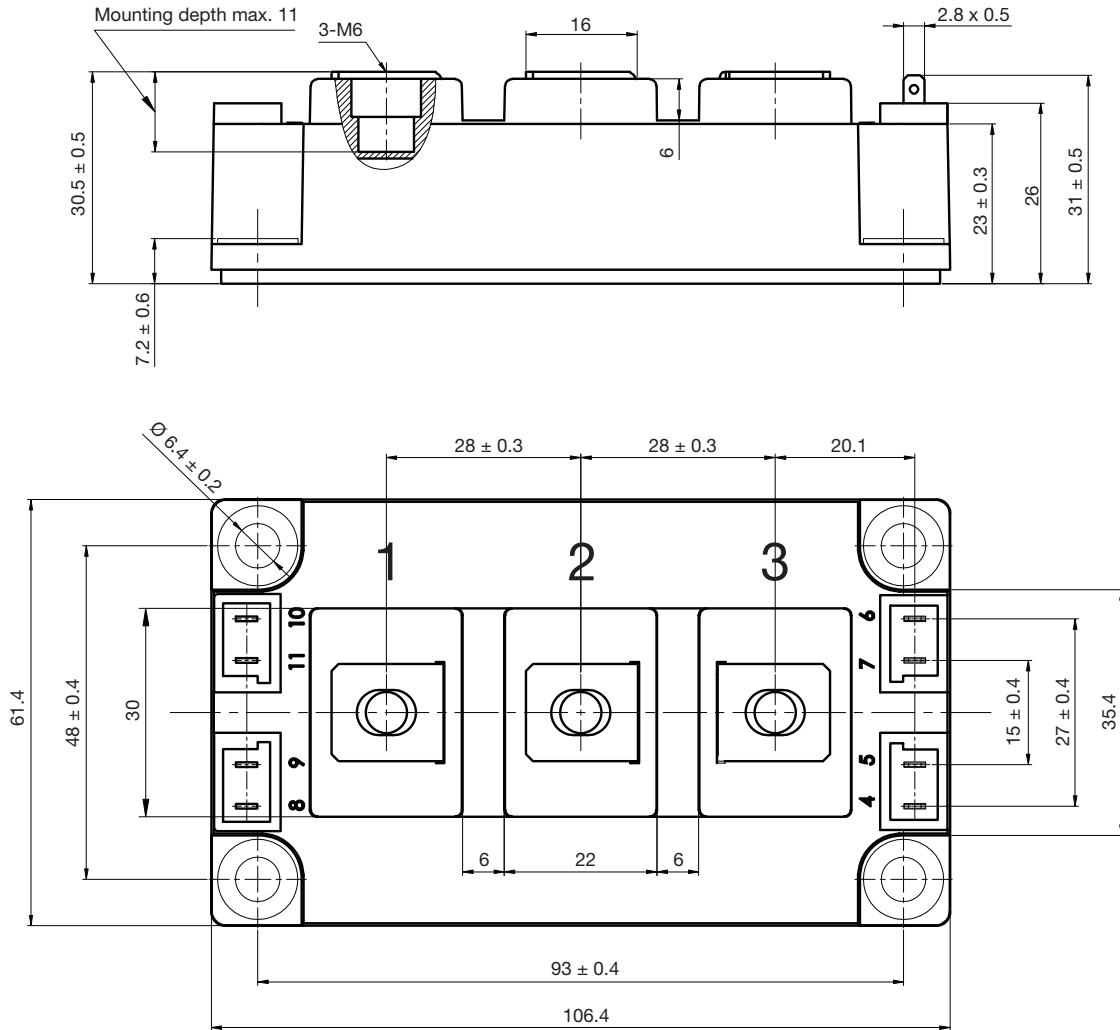
LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?95525
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Double INT-A-PAK

DIMENSIONS in millimeters (inches)





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